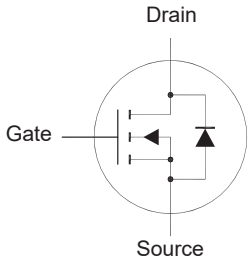
N-Channel Enhancement Mode MOSFET

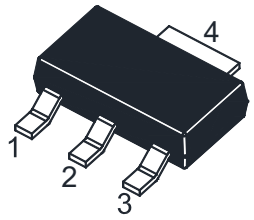
Features

- Low $R_{DS(ON)}$
- Halogen and Antimony Free(HAF), RoHS compliant

Applications

- Boost converters
- Synchronous rectifiers
- LED backlighting





1.Gate 2.Drain 3.Source 4.Drain
SOT-223 Plastic Package

Key Parameters

Parameter	Value	Unit
BV_{DSS}	60	V
$R_{DS(ON)}$ Max	42 @ V_{GS} = 10 V	mΩ
	50 @ V_{GS} = 4.5 V	
$V_{GS(th)}$ typ	1.5	V
Q_g typ	19 @ V_{GS} = 10 V	nC

Absolute Maximum Ratings (at T_a = 25℃ unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain-Source Voltage		V_{DS}	60	V
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current	T_c = 25℃	I_D	12	A
	T_c = 100℃		7.5	
Peak Drain Current, Pulsed [1]		I_{DM}	45	A
Avalanche Current		I_{AS}	9.8	A
Single Pulse Avalanche Energy [2]		E_{AS}	4.8	mJ
Power Dissipation	T_c = 25℃	P_D	10.7	W
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to + 150	℃

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	11.6	℃/W
Thermal Resistance from Junction to Ambient [3]	$R_{\theta JA}$	57	℃/W

[1] Pulse Test: Pulse Width ≤ 100 μs, Duty Cycle ≤ 2%, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ = 150°C.
[2] Limited by $T_{J(MAX)}$, starting T_J = 25 °C, L = 0.1 mH, R_g = 25 Ω, I_{AS} = 9.8 A, V_{GS} = 10 V.
[3] Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

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Characteristics at T_a = 25℃ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at I_D = 250 µA	BV_{DSS}	60	-	-	V
Drain-Source Leakage Current at V_{DS} = 48 V	I_{DSS}	-	-	1	µA
Gate-Source Leakage Current at V_{GS} = ± 20 V	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at V_{DS} = V_{GS}, I_D = 250 µA	$V_{GS(th)}$	1.2	-	2.5	V
Drain-Source On-State Resistance at V_{GS} = 10 V, I_D = 15 A at V_{GS} = 4.5 V, I_D = 10 A	$R_{DS(on)}$	- -	35 -	42 50	mΩ
DYNAMIC PARAMETERS					
Forward Transconductance at V_{DS} = 5 V, I_D = 15 A	g_{fs}	-	13.1	-	S
Gate Resistance at V_{GS} = 0 V, V_{DS} = 0 V, f = 1 MHz	R_g	-	0.8	-	Ω
Input Capacitance at V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz	C_{iss}	-	1087	-	pF
Output Capacitance at V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz	C_{oss}	-	47	-	pF
Reverse Transfer Capacitance at V_{GS} = 0 V, V_{DS} = 30 V, f = 1 MHz	C_{rss}	-	43	-	pF
Total Gate Charge at V_{DS} = 30 V, I_D = 15 A, V_{GS} = 10 V at V_{DS} = 30 V, I_D = 15 A, V_{GS} = 4.5 V	Q_g	- -	19 8	- -	nC
Gate Source Charge at V_{DS} = 30 V, I_D = 15 A, V_{GS} = 10 V	Q_{gs}	-	4	-	nC
Gate Drain Charge at V_{DS} = 30 V, I_D = 15 A, V_{GS} = 10 V	Q_{gd}	-	2	-	nC
Turn-On Delay Time at V_{DS} = 30 V, V_{GS} = 10 V, I_D = 15 A, R_g = 3.3 Ω	$t_{d(on)}$	-	10	-	ns
Turn-On Rise Time at V_{DS} = 30 V, V_{GS} = 10 V, I_D = 15 A, R_g = 3.3 Ω	t_r	-	21	-	ns
Turn-Off Delay Time at V_{DS} = 30 V, V_{GS} = 10 V, I_D = 15 A, R_g = 3.3 Ω	$t_{d(off)}$	-	9	-	ns
Turn-Off Fall Time at V_{DS} = 30 V, V_{GS} = 10 V, I_D = 15 A, R_g = 3.3 Ω	t_f	-	2	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at I_S = 1 A, V_{GS} = 0 V	V_{SD}	-	-	1.3	V
Body-Diode Continuous Current	I_S	-	-	12	A
Body-Diode Continuous Current, Pulsed	I_{SM}	-	-	45	A
Body Diode Reverse Recovery Time at I_S = 15 A, di/dt = 100 A / µs	t_{rr}	-	8.3	-	ns
Body Diode Reverse Recovery Charge at I_S = 15 A, di/dt = 100 A / µs	Q_{rr}	-	4.9	-	nC

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Electrical Characteristics Curves

Fig. 1 Typical Output Characteristics

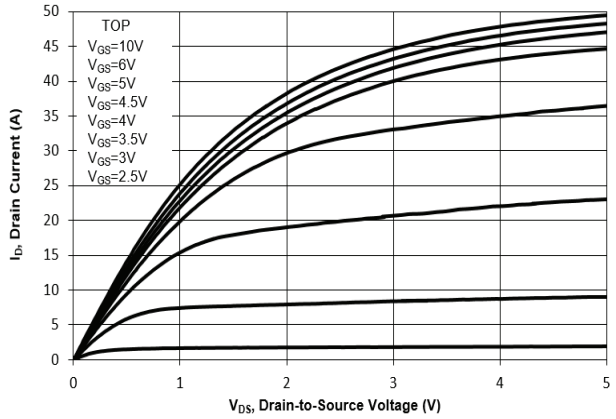


Fig. 2 Typical Transfer Characteristics

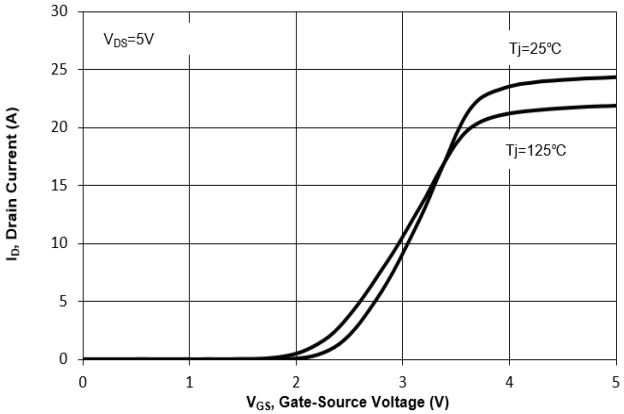


Fig. 3 On-Resistance vs. Drain Current

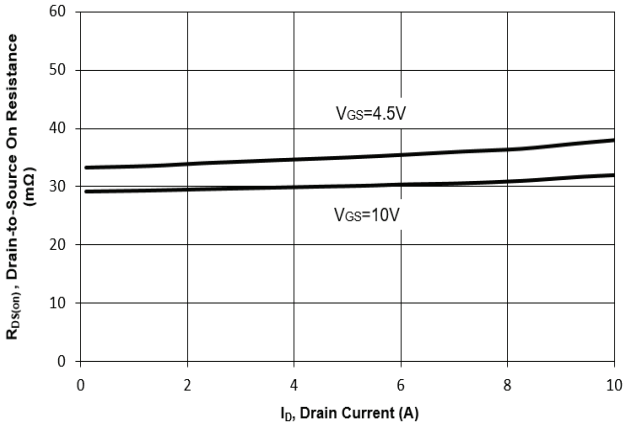


Fig. 4 On-Resistance vs. Gate to Source Voltage

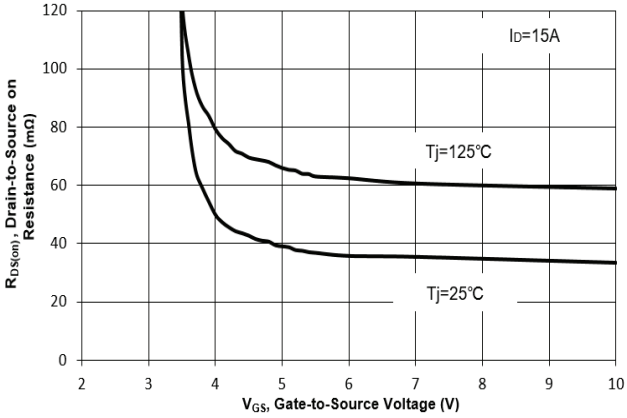


Fig. 5 On-Resistance vs.T_j

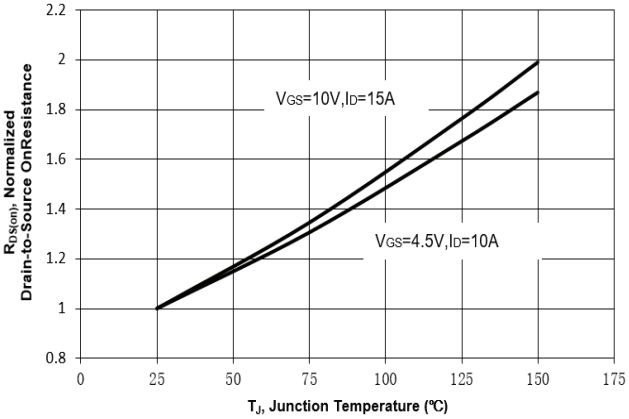
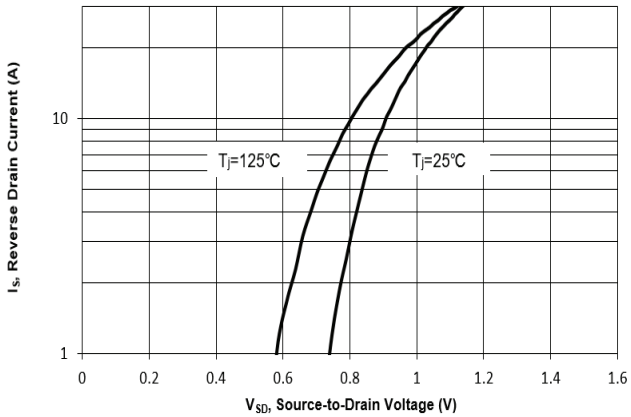


Fig. 6 Typical Body-Diode Forward Characteristics



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Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

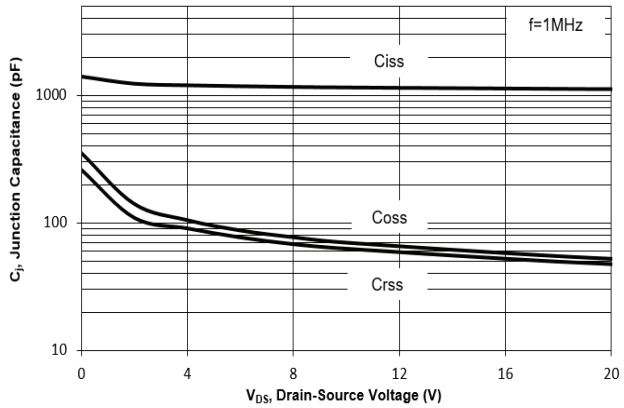


Fig. 8 Drain-Source Leakage Current vs. T_j

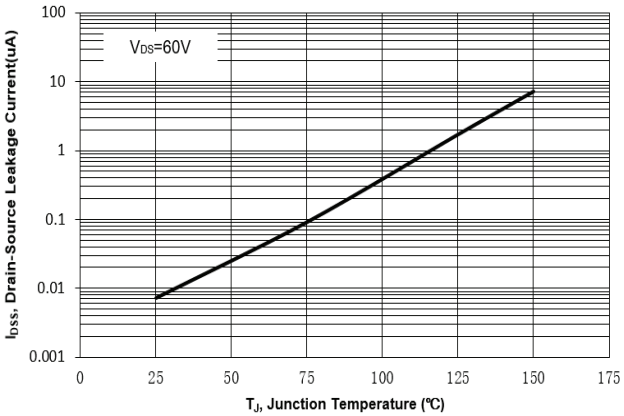


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

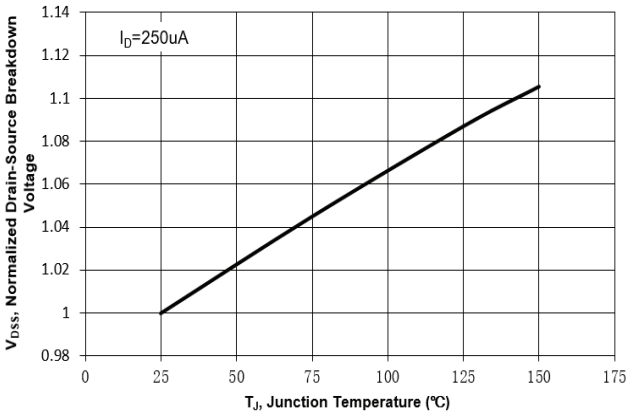


Fig. 10 Gate Threshold Variation vs. T_j

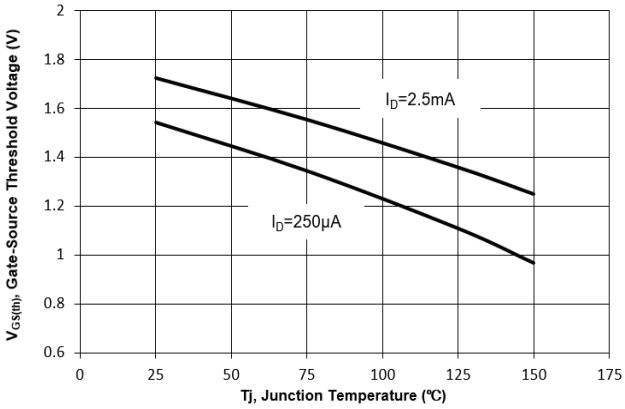


Fig. 11 Gate Charge

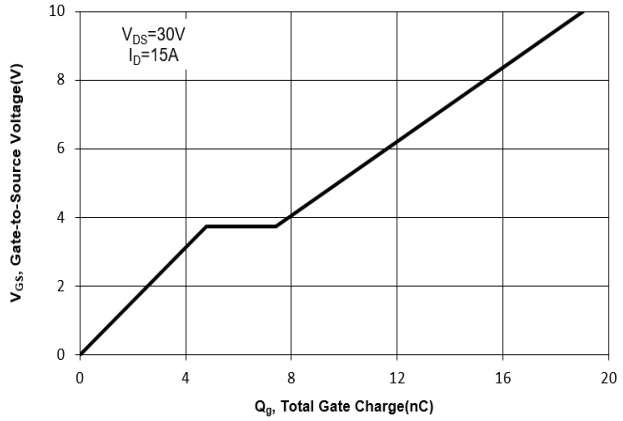
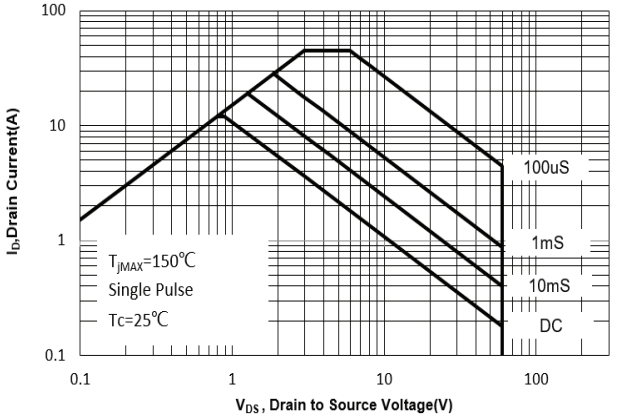


Fig. 12 Safe Operation Area



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Electrical Characteristics Curves

Fig. 13 Normalized Maximum Transient Thermal Impedance($Z_{\Theta JC}$)

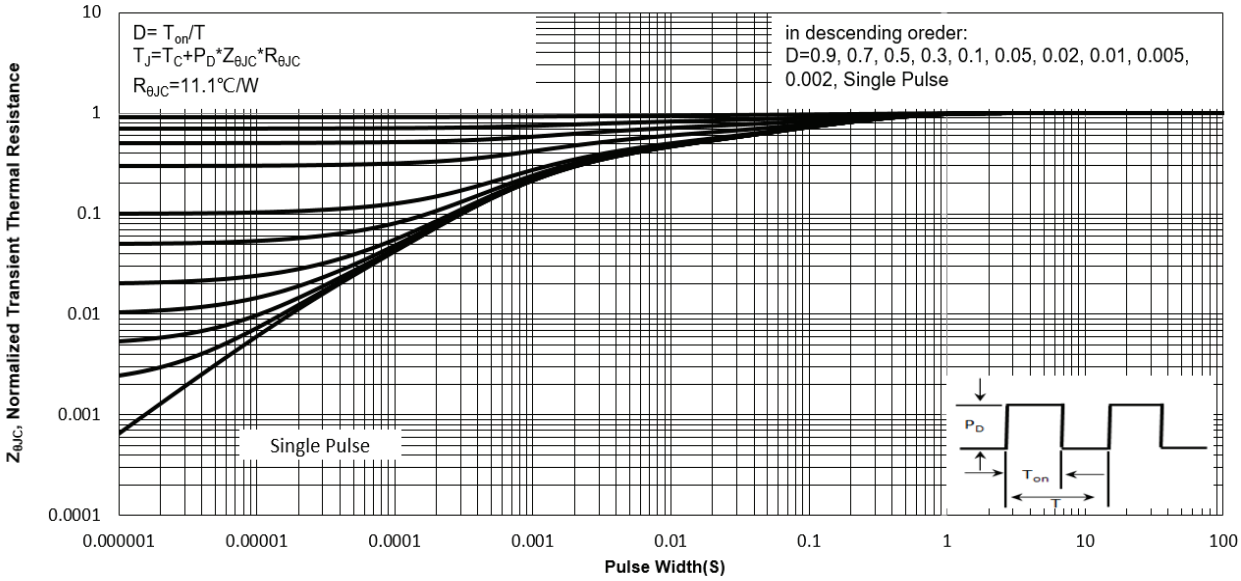
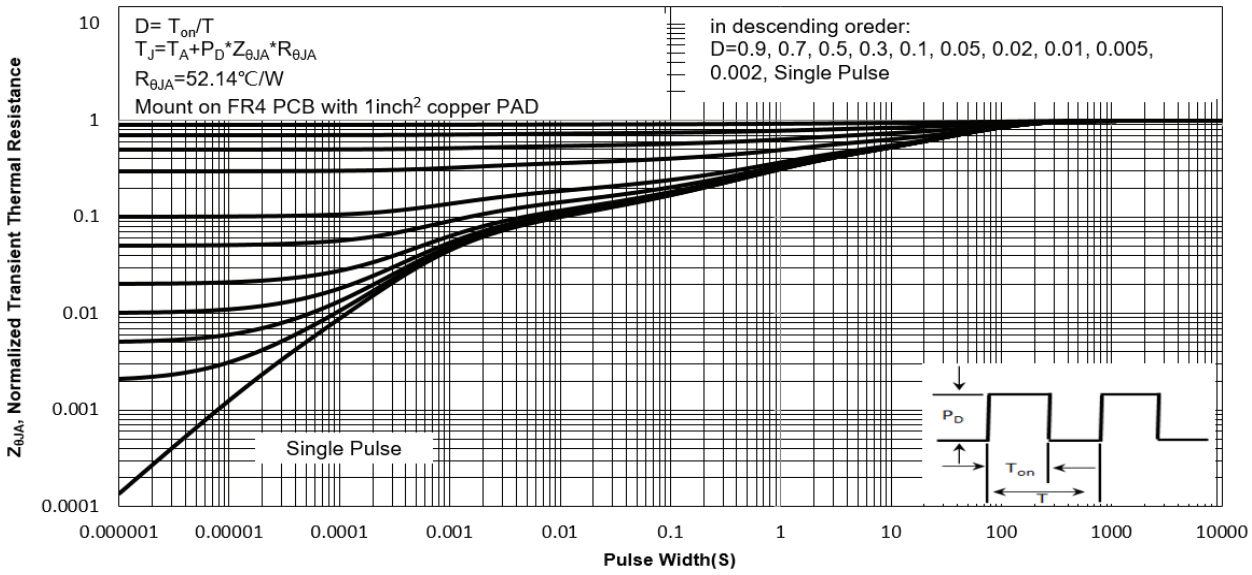


Fig. 14 Normalized Maximum Transient Thermal Impedance($Z_{\Theta JA}$)



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Test Circuits

Fig.1-1 Switching times test circuit

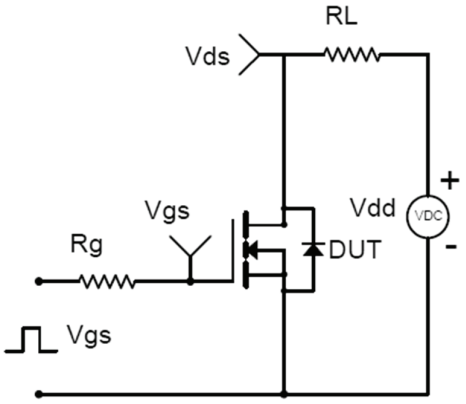


Fig.1-2 Switching Waveform

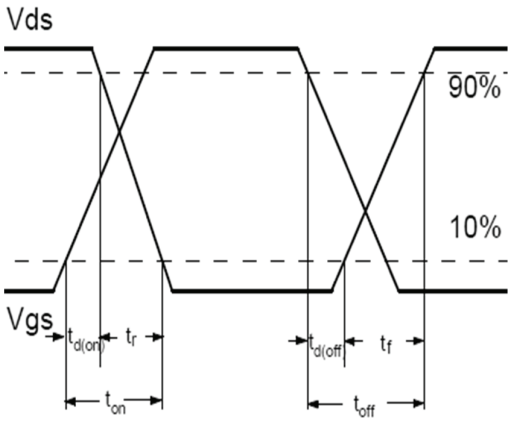


Fig.2-1 Gate charge test circuit

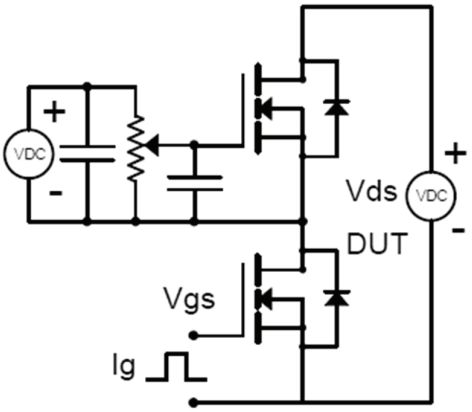


Fig.2-2 Gate charge waveform

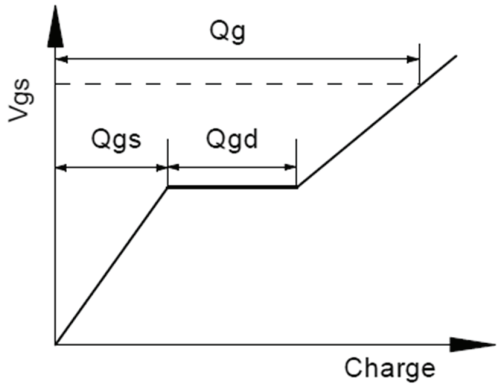


Fig.3-1 Avalanche test circuit

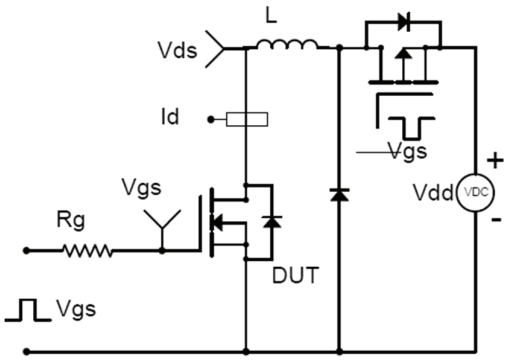
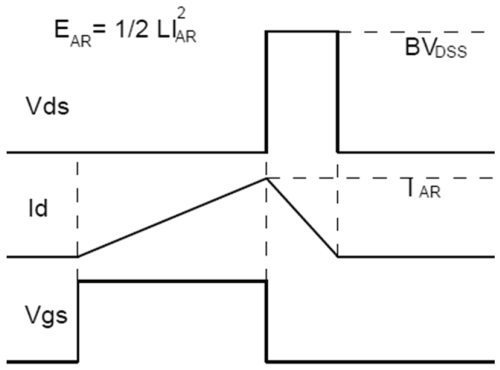


Fig.3-2 Avalanche waveform



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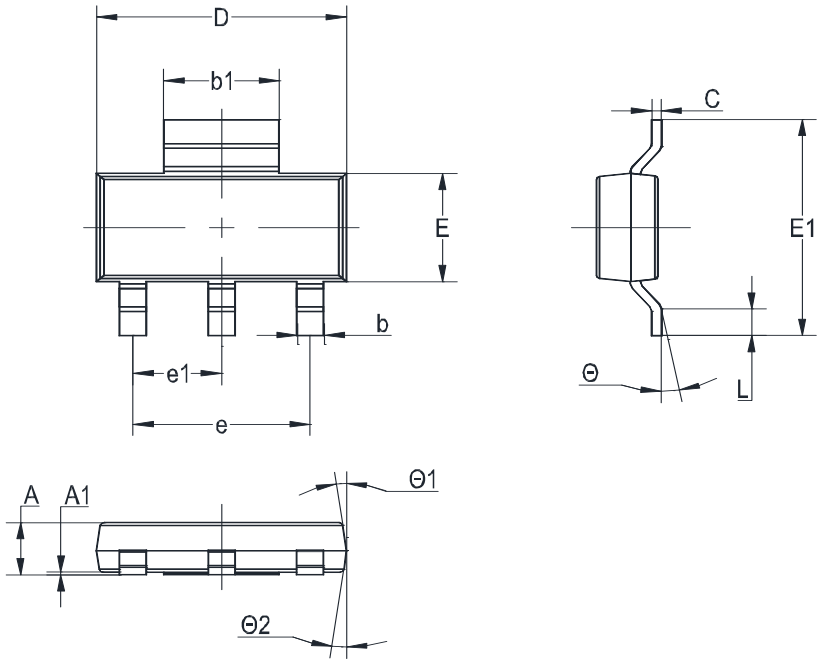
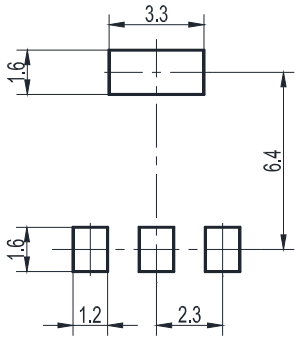
Package Outline (Dimensions in mm)

SOT-223



Unit	A	A1	b	b1	C	D	E	E1	e	e1	L	Θ	Θ1	Θ2
mm	1.8 1.5	0.1 MAX	0.8 0.6	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	7.3 6.7	4.6 TYP	2.3 TYP	1.1 0.7	10° 0°	7° 0°	7° 0°

Recommended Soldering Footprint

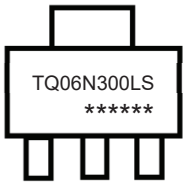


Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOT-223	12	8 ± 0.1	0.315 ± 0.004	330	13	3,000

Marking information

" TQ06N300LS " = Part No.
" ****** " = Date Code Marking
Font type: Arial



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